Supporting Information for

Improvement of Thermal Conductivities for Epoxy Composites via Incorporating Poly (vinyl benzal) Coated h-BN Fillers and Solvent Assisted Dispersion

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Table S1. Preparation of h-BN@PVB by Different Reactant Ratios and Conditions

PVA (g)	Benzaldehyde (mL)	*p*-TsOH (g)	DW or DMSO (mL)	h-BN (g)	PVB content in h-BN@PVB (wt%)[a]
0.10	0.2	0.5	DW:100	5.0	2
0.25	0.8	0.5	DW:100	5.0	6
0.50	1.0	0.5	DW:100	5.0	10
0.50	1.5	0.5	DW:100	5.0	15
0.80	1.8	0.5	DW:100	5.0	18
0.50	1.0	0.5	DMSO:100	5.0	11

[a] The PVB content in h-BN@PVB were verified by TGA, and the PVB in h-BN@PVB is the partially reacted PVA.

Apart from the reaction time, temperature and pH, the concentration of reaction medium and the ratio of PVA, benzaldehyde and h-BN will also affect PVB content.

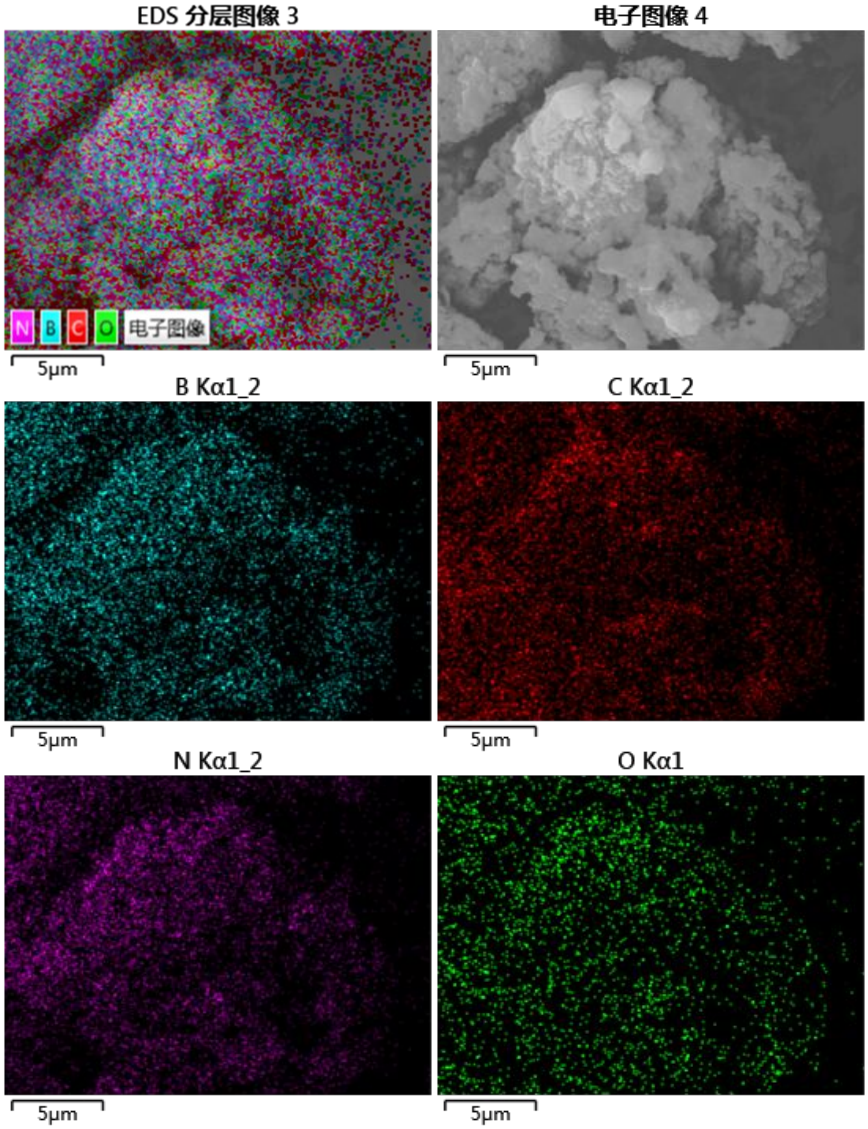

Figure S1. EDS analyses of h-BN@PVB.